QOCVO

SiC JFET Division

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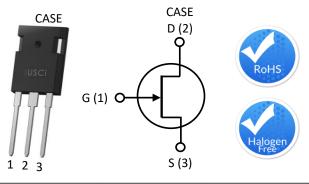
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Datasheet

Description

United Silicon Carbide, Inc offers the high-performance G3 SiC normallyon JFET transistors. This series exhibits ultra-low on resistance ($R_{DS(ON)}$) and gate charge (Q_G) allowing for low conduction and switching loss. The device normally-on characteristics with low $R_{DS(ON)}$ at $V_{GS} = 0$ V is also ideal for current protection circuits without the need for active control, as well as for cascode operation.



Part Number	Package	Marking
UJ3N120070K3S	TO-247-3L	UJ3N120070K3S

Typical Applications

- Over current protection circuits
- DC-AC inverters
- Switch mode power supplies
- Power factor correction modules
- Motor drives
- Induction heating

Features

- Typical on-resistance $R_{DS(on),typ}$ of 70m Ω
- Voltage controlled
- Maximum operating temperature of 175°C
- Extremely fast switching not dependent on temperature
- Low gate charge
- Low intrinsic capacitance
- RoHS compliant

Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units	
Drain-source voltage	V _{DS}		1200	V	
Gate-source voltage	N	DC	-20 to +3	- v	
	V _{GS} –	AC ⁽¹⁾	-20 to +20		
Continuous drain current ⁽²⁾		$T_c = 25^{\circ}C$	33.5	А	
	I _D –	T _C = 100°C	24.5	A	
Pulsed drain current ⁽³⁾	I _{DM}	$T_{\rm C} = 25^{\circ}{\rm C}$	85	А	
Power dissipation	P _{tot}	T _c =25°C	254	W	
Maximum junction temperature	T _{J,max}		175	°C	
Operating and storage temperature	T _J , T _{STG}		-55 to 175	°C	
Max. lead temperature for soldering, 1/8" from case for 5 seconds	TL		250	°C	

(1) +20V AC rating applies for turn-on pulses <200ns applied with external $R_{G} > 1\Omega$.

(2) Limited by T_{J,max}

(3) Pulse width t_p limited by T_{J,max}



Datasheet

Electrical Characteristics (T_J = +25°C unless otherwise specified)

Typical Performance - Static

Deremeter	Symbol	Test Conditions	Value			Units	
Parameter	Symbol	Test Conditions	Min	Тур	Max	Onits	
Drain-source breakdown voltage	BV _{DS}	V _{GS} = - 20V, I _D =1mA	1200			V	
Total drain leakage current	Ι _D	V _{DS} = 1200V, V _{GS} = -20V, T _J = 25°C		5	30		
		V _{DS} = 1200V, V _{GS} = -20V, T _J = 175°C		18		μΑ	
Total gate leakage current	Ι _G	V _{GS} =-20V, T _j =25°C		5	50	μА	
		V _{GS} =-20V, T _j =175°C		20			
Drain-source on-resistance	R _{DS(on)}	V _{GS} =2V, I _D =10A, T _J = 25°C		63		-	
		V _{GS} =0V, I _D =10A, T _J = 25°C		70	90		
		V _{GS} =2V, I _D =10A, T _J = 175°C		139		– mΩ	
		V _{GS} =0V, I _D =10A, T _J = 175°C		154			
Gate threshold voltage	V _{G(th)}	V _{DS} = 5V, I _D = 35mA	-14	-11.5	-6	V	
Gate resistance	R _G	f = 1MHz, open drain		3.3		Ω	



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Typical Performance - Dynamic

Parameter	symbol	Test Conditions	Value			Units
Parameter	Symbol		Min	Тур	Max	Units
Input capacitance	C _{iss}	V _{DS} = 100V,		985		pF
Output capacitance	C _{oss}	V _{GS} = -20V,		100		
Reverse transfer capacitance	C _{rss}	f = 100kHz		95		
Effective output capacitance, energy related	C _{oss(er)}	V _{DS} = 0V to 800V, V _{GS} = -20V		52		pF
Total gate charge	Q _G	N/ 0001/1 054		116		
Gate-drain charge	Q _{GD}	V_{DS} =800V, I_{D} = 25A, V_{GS} =-18V to 0V		63		nC
Gate-source charge	Q_{GS}	V _{GS} =-18V 10 0V		11		
Turn-on delay time	t _{d(on)}			17		ns μ
Rise time	t _r	V _{DS} =800V, I _D =25A,		25		
Turn-off delay time	t _{d(off)}	Gate Driver =-18V to 0V, $R_{G,EXT} = 1\Omega,$ Inductive Load, FWD: UJ2D1215T $T_J = 25^{\circ}C$		29		
Fall time	t _f			39		
Turn-on energy	E _{ON}			434		
Turn-off energy	E _{OFF}			393		
Total switching energy	E _{TOTAL}			827		
Turn-on delay time	t _{d(on)}	$V_{DS}=800V, I_{D}=25A,$ Gate Driver =-18V to 0V, $R_{G,EXT} = 1\Omega,$ Inductive Load, FWD: UJ2D1215T $T_{J} = 150^{\circ}C$		17		- ns
Rise time	t _r			23		
Turn-off delay time	t _{d(off)}			25		
Fall time	t _f			24		
Turn-on energy	E _{ON}			418		
Turn-off energy	E _{OFF}			278		μ
Total switching energy	E _{TOTAL}			696		

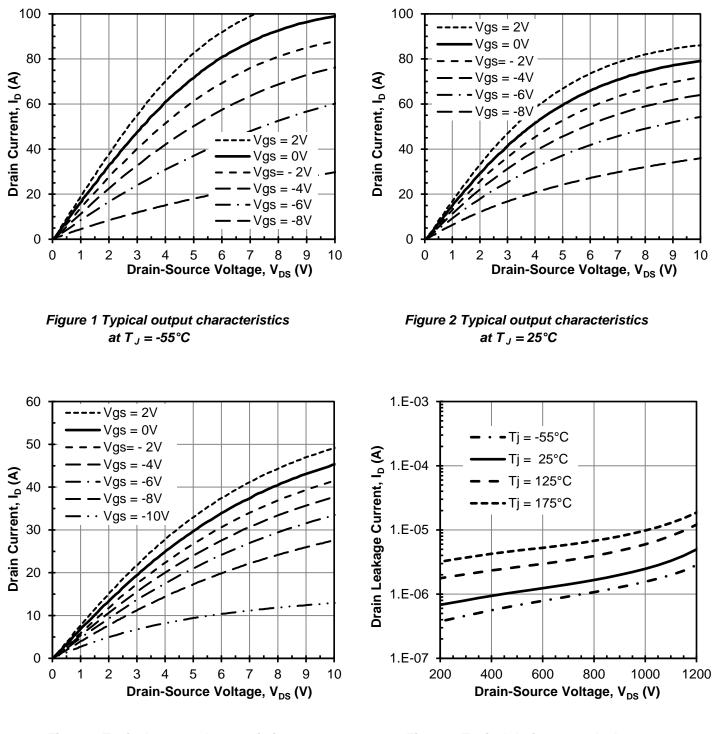
Thermal Characteristics

Parameter	symbol	Test Conditions	Value			Units
			Min	Тур	Max	Units
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.45	0.59	°C/W



Datasheet

Typical Performance Diagrams



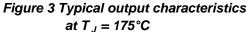
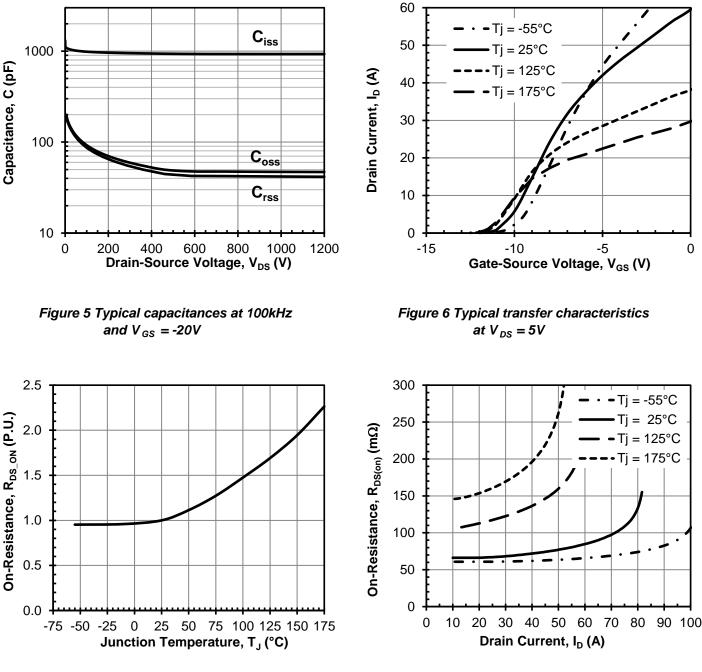
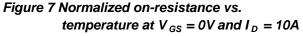
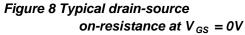


Figure 4 Typical drain-source leakage at $V_{GS} = -20V$











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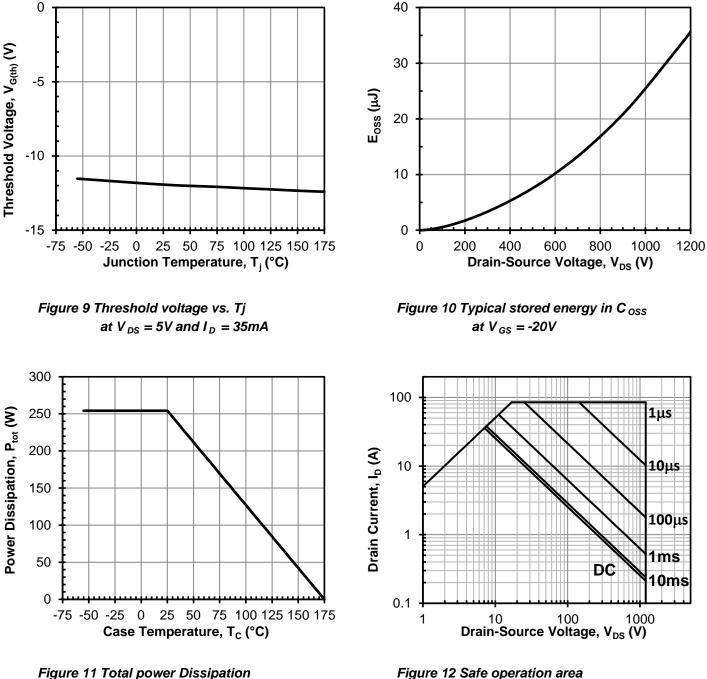
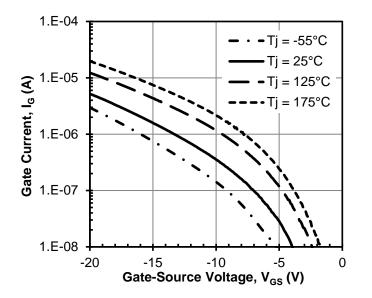
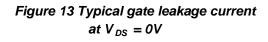
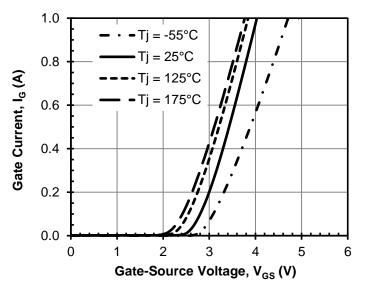


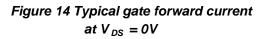
Figure 12 Safe operation area $T_c = 25^{\circ}C$, Parameter t_p











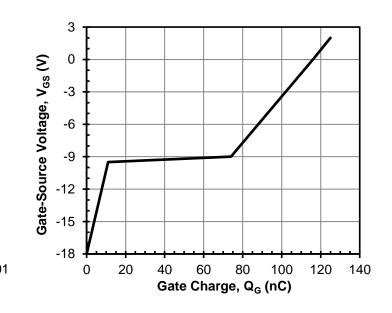


Figure 16 Typical gate charge at $V_{DS} = 800V$ and $I_D = 25A$

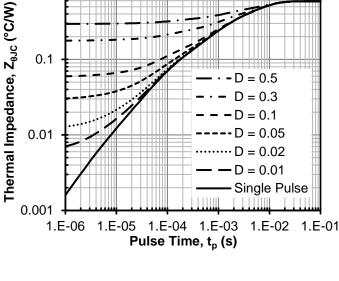


Figure 15 Maximum transient thermal impedance

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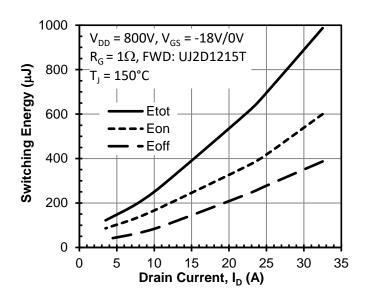
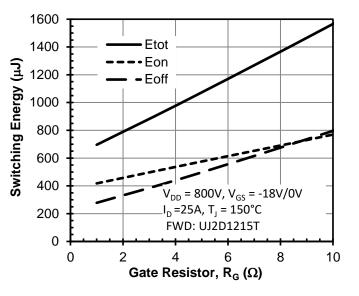
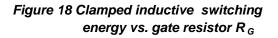


Figure 17 Clamped inductive switching energy vs. drain current at $T_J = 150^{\circ}$ C





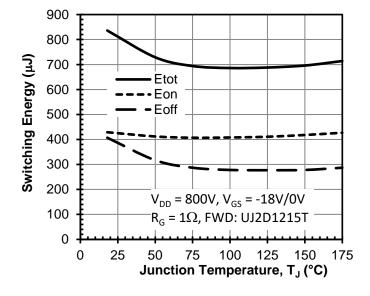


Figure 19 Clamped inductive switching energy vs. junction temperature at $I_D = 25A$



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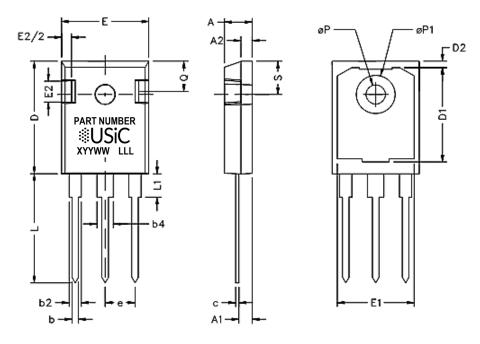
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TO-247-3L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

PACKAGE OUTLINE



SYM	INC	HES	MILLIMETERS		
	MIN	MAX	MIN	МАХ	
A	0.185	0.209	4.699	5.309	
A1	0.087	0.102	2.21	2.61	
A2	0.059	0.098	1.499	2.489	
b	0.039	0.055	0.991	1.397	
b2	0.065	0.094	1.651	2.388	
b4	0.102	0.135	2.591	3.429	
С	0.015	0.035	0.381	0.889	
D	0.819	0.845	20.803	21.463	
D1	0.515	-	13.081	-	
D2	0.02	0.053	0.508	1.346	
E	0.61	0.64	15.494	16.256	
е	0.214	4 BSC	5.44	BSC	
E1	0.53	-	13.462	-	
E2	0.135	0.157	3.429	3.988	
L	0.78	0.8	19.812	20.32	
L1	-	0.177	-	4.496	
ØР	0.14	0.144	3.556	3.658	
ØP1	0.278	0.291	7.061	7.391	
Q	0.212	0.244	5.385	6.198	
S	0.243	3 BSC	6.17 BSC		



PART MARKING

PART NUMBER SUSSE XYYWW LLL

PART NUMBER = REFER TO DS_PN DECODER FOR DETAILS

X = ASSEMBLY SITE YY = YEAR WW = WORK WEEK LLL = LOT ID

PACKING TYPE

ANTI-STATIC TUBE

QUANTITY / TUBE : 30 UNITS

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